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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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# RClamp0501T Low Capacitance 1-Line ESD protection

# PROTECTION PRODUCTS - RailClamp®

## Description

RailClamp® TVS arrays are ultra low capacitance ESD protection devices designed to protect high speed data interfaces. This series has been specifically designed to protect sensitive components which are connected to high-speed data and transmission lines from overvoltage caused by ESD (electrostatic discharge), CDE (Cable Discharge Events), and EFT (electrical fast transients).

The RClamp®0501T has a maximum capacitance of only 1.5pF. This allows it to be used on circuits operating in excess of 100MHz without signal attenuation. They may be used to meet the ESD immunity requirements of IEC 61000-4-2.

The RClamp0501T is in a 2-pin SLP1006P2T package measuring  $1.0 \times 0.6 \times 0.4$ mm. The leads are spaced at a pitch of 0.65mm and feature a lead-free finish. Each device will protect one high-speed line operating at 5 volts. It gives the designer the flexibility to protect single lines in applications where arrays are not practical. The combination of small size, low capacitance, and high ESD surge capability makes them ideal for protection of high speed digital lines in cellular hand-sets and other portable electronic devices.

#### Features

- ◆ Transient protection for data lines to IEC 61000-4-2 (ESD) ±25kV (air), ±20kV (contact) IEC 61000-4-4 (EFT) 40A (tp = 5/50ns) Cable Discharge Event (CDE)
- ◆ Ultra-small package (1.0 x 0.6 x 0.4mm)
- Protects one data or I/O line
- Low capacitance: 1.5pF
- Low clamping voltage
- Low operating voltage: 5.0V
- Solid-state silicon-avalanche technology

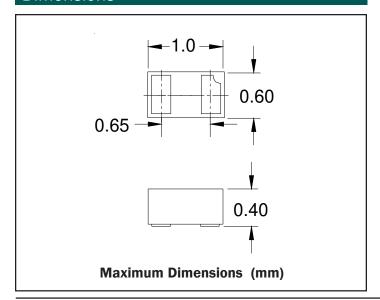
#### Mechanical Characteristics

- SLP1006P2T package
- Molding compound flammability rating: UL 94V-0
- Marking: Marking code
- Packaging: Tape and Reel
- Lead Finish: NiPdAu
- ◆ Pb-Free, Halogen Free, RoHS/WEEE Compliant

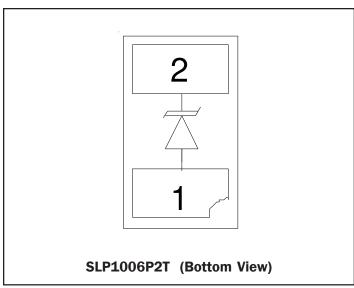
#### **Applications**

- Cellular Handsets & Accessories
- Multimedia Card Interfaces
- Digital Signal Lines
- ◆ SIM Ports
- Keypads
- SD Lines

#### **Dimensions**



## Schematic & PIN Configuration





# Absolute Maximum Rating

Rating	Symbol	Value	Units
Peak Pulse Power (tp = 8/20μs)	P <sub>pk</sub>	150	Watts
Peak Pulse Current (tp = 8/20µs)	I <sub>PP</sub>	10	А
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V <sub>ESD</sub>	+/- 25 +/- 20	kV
Operating Temperature	T,	-55 to +125	°C
Storage Temperature	T <sub>stg</sub>	-55 to +150	°C

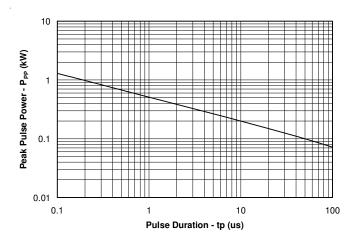
# Electrical Characteristics (T=25°C)

					1	
Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V <sub>RWM</sub>				5	V
Reverse Breakdown Voltage	V <sub>BR</sub>	I <sub>t</sub> = 1mA	6.9		9.7	V
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> = 5V, T=25°C			0.100	μΑ
Clamping Voltage	V <sub>c</sub>	I <sub>pp</sub> = 3A, tp = 8/20μs Pin 2 to 1			12	V
Clamping Voltage	V <sub>c</sub>	I <sub>pp</sub> = 10A, tp = 8/20μs Pin 2 to 1			15	V
Forward Clamping Voltage	V <sub>F</sub>	I <sub>pp</sub> = 3A, tp = 8/20μs Pin 1 to 2			4	V
Junction Capacitance	C <sub>j</sub>	V <sub>R</sub> = 0V, f = 1MHz T = 25°C	0.6		1.5	pF
Junction Capacitance	C <sub>j</sub>	$V_{R} = 0V, f = 1MHz$ T = 0 to +85°C	0.5		1.7	pF

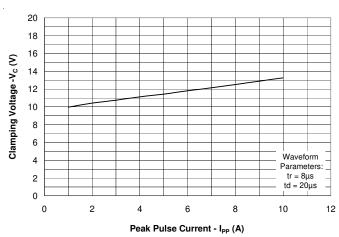


## **Typical Characteristics**

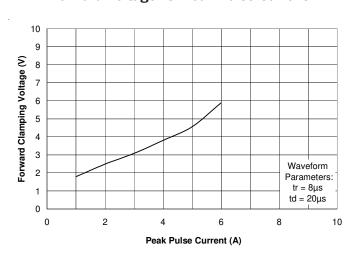
#### Non-Repetitive Peak Pulse Power vs. Pulse Time



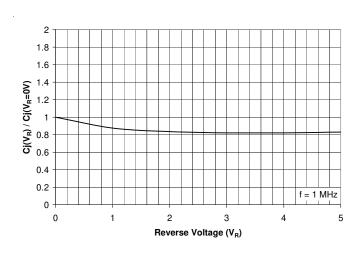
### Clamping Voltage vs. Peak Pulse Current



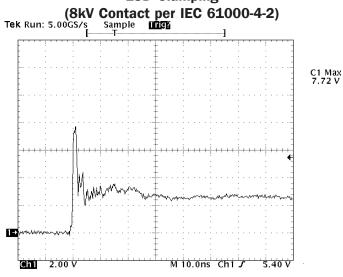
#### Forward Voltage vs. Peak Pulse Current



#### **Normalized Capacitance vs. Reverse Voltage**

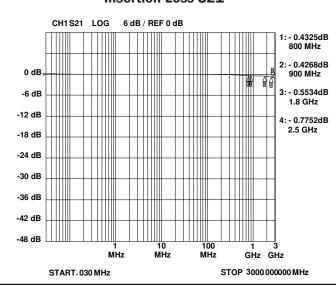


## ESD Clamping



Note: Data is taken with a 10x attenuator

#### **Insertion Loss S21**





## **Applications Information**

#### **Device Connection Options**

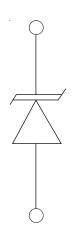
These low capacitance TVS diodes are designed to provide common mode protection for one high-speed line. The device is unidirectional and may be used on lines where the signal polarity is positive.

# Circuit Board Layout Recommendations for Suppression of ESD.

Good circuit board layout is critical for the suppression of ESD induced transients. The following guidelines are recommended:

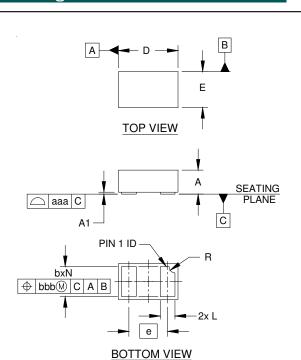
- Place the TVS near the input terminals or connectors to restrict transient coupling.
- Minimize the path length between the TVS and the protected line.
- Minimize all conductive loops including power and ground loops.
- The ESD transient return path to ground should be kept as short as possible.
- Never run critical signals near board edges.
- Use ground planes whenever possible.

#### **Equivalent Circuit Diagram**





## Outline Drawing - SLP1006P2T

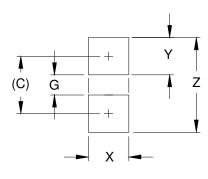


DIMENSIONS						
DIM	INCHES			MILLIMETERS		
ווווטן	MIN	NOM	MAX	MIN	NOM	MAX
Α	.015	.016	.017	0.37	0.40	0.43
A1	.000	.001	.002	0.00	0.03	0.05
b	.018	.020	.022	0.45	0.50	0.55
D	.035	.039	.043	0.90	1.00	1.10
E	.020	.024	.028	0.50	0.60	0.70
е	.026 BSC		0.	0.65 BSC		
L	.008	.010	.012	0.20	0.25	0.30
R	.002	.004	.006	0.05	0.10	0.15
N	2			2		
aaa	.003		0.08			
bbb	.004		0.10			

#### NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).

## Land Pattern - SLP1006P2T



	DIMENS	IONS
DIM	INCHES	MILLIMETERS
С	(.033)	(0.85)
G	.012	0.30
X	.024	0.60
Υ	.022	0.55
Z	.055	1.40

#### NOTES:

- 1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.



## Marking Code



## Ordering Information

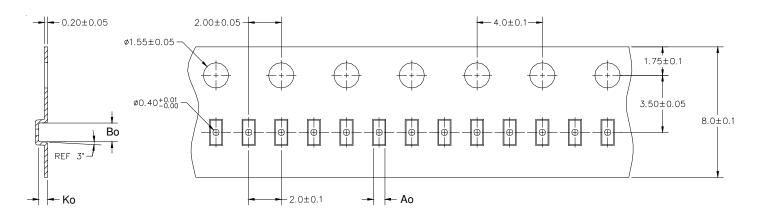
Part Number	Qty per Reel	Reel Size	
RClamp0501T.TNT	10,000	7 Inch	

RailClamp and RClamp are trademarks of Semtech Corporation.

#### Notes:

1) Marking will also include line matrix date code

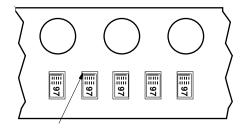
## **Carrier Tape Specification**



A0	во	ко
0.70 +/-0.05 mm	1.15 +/-0.05 mm	0.55 +/-0.05 mm

Note: All dimensions in mm unless otherwise specified

#### **Device Orientation in Tape**



Pin 2 Cathode Location (Towards Sprocket Holes)

## **Contact Information**

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